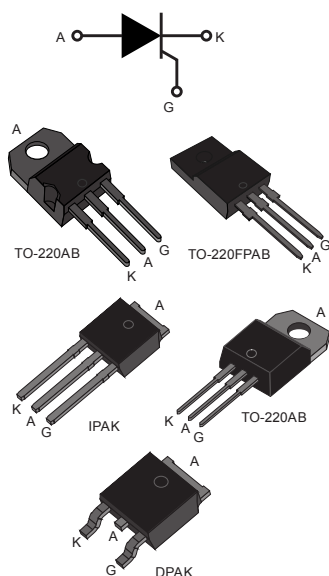


## Sensitive and standard 8 A SCRs



### Features

- On-state rms current,  $I_{T(RMS)}$  8 A
- Repetitive peak off-state voltage,  $V_{DRM}/V_{RRM}$  600 and 800 V
- Triggering gate current,  $I_{GT}$  0.2 to 15 mA

### Description

Available either in sensitive (TS8) or standard (TN8 / TYN) gate triggering levels, the 8 A SCR series is suitable to fit all modes of control found in applications such as overvoltage crowbar protection, motor control circuits in power tools and kitchen aids, inrush current limiting circuits, capacitive discharge ignition and voltage regulation circuits.

Available in through-hole or surface-mount packages, they provide an optimized performance in a limited space.

#### Product status link

[TN805, TN815, TS820, TYN608](#)

| Product summary |                                    |       |                         |            |
|-----------------|------------------------------------|-------|-------------------------|------------|
| Order code      | Voltage (x00)<br>$V_{DRM}/V_{RRM}$ |       | Sensitivity<br>$I_{GT}$ | Package    |
|                 | 600 V                              | 800 V |                         |            |
| TS820-600B      | X                                  |       | 0.2 mA                  | DPAK       |
| TS820-600H      | X                                  |       | 0.2 mA                  | IPAK       |
| TS820-600T      | X                                  |       | 0.2 mA                  | TO-220AB   |
| TS820-600FP     | X                                  |       | 0.2 mA                  | TO-220FPAB |
| TN805-600B      | X                                  |       | 5 mA                    | DPAK       |
| TN815-x00B      | X                                  | X     | 15 mA                   | DPAK       |
| TN815-800H      |                                    | X     | 15 mA                   | IPAK       |
| TYN608RG        | X                                  |       | 15 mA                   | TO-220AB   |

# 1 Characteristics

**Table 1. Absolute ratings (limiting values)**

| Symbol              | Parameters                                                                                                  |                                    | Value                   |             | Unit |                  |
|---------------------|-------------------------------------------------------------------------------------------------------------|------------------------------------|-------------------------|-------------|------|------------------|
|                     |                                                                                                             |                                    | TN805<br>TN815<br>TS820 | TYN608      |      |                  |
| I <sub>T(RMS)</sub> | RMS on-state current On-state rms current<br>(180° conduction angle)                                        | T <sub>C</sub> = 110 °C            | 8                       |             | A    |                  |
|                     |                                                                                                             | TO-220FPAB, T <sub>C</sub> = 91 °C |                         |             |      |                  |
| I <sub>T(AV)</sub>  | Average on-state current (180° conduction angle)                                                            | T <sub>C</sub> = 110 °C            | 5                       |             | A    |                  |
|                     |                                                                                                             | TO-220FPAB, T <sub>C</sub> = 91 °C |                         |             |      |                  |
| I <sub>TSM</sub>    | Non repetitive surge peak on-state current                                                                  | t <sub>p</sub> = 8.3 ms            | 73                      | 100         | A    |                  |
|                     |                                                                                                             | t <sub>p</sub> = 10 ms             | 70                      | 95          |      |                  |
| I <sup>2</sup> t    | I <sup>2</sup> t value for fusing                                                                           | t <sub>p</sub> = 10 ms             | T <sub>j</sub> = 25 °C  | 24.5        | 45   | A <sup>2</sup> s |
| di/dt               | Critical rate of rise of on-state current<br>I <sub>G</sub> = 2 x I <sub>GT</sub> , t <sub>r</sub> ≤ 100 ns | F = 60 Hz                          | T <sub>j</sub> = 125 °C | 50          |      | A/μs             |
| I <sub>GM</sub>     | Peak gate current                                                                                           | t <sub>p</sub> = 20 μs             | T <sub>j</sub> = 125 °C | 4           |      | A                |
| P <sub>G(AV)</sub>  | Average gate power dissipation                                                                              |                                    | T <sub>j</sub> = 125 °C | 1           |      | W                |
| T <sub>stg</sub>    | Storage junction temperature range                                                                          |                                    |                         | -40 to +150 |      | °C               |
| T <sub>j</sub>      | Operating junction temperature range                                                                        |                                    |                         | -40 to +125 |      | °C               |
| V <sub>RGM</sub>    | Maximum peak reverse gate voltage (for TN8x5 and TYN608 only)                                               |                                    |                         | 5           |      | V                |

**Table 2. Sensitive electrical characteristics ( $T_j = 25\text{ °C}$ , unless otherwise specified)**

| Symbol                 | Parameter                                                                   |                       |      | TS820 | Unit       |
|------------------------|-----------------------------------------------------------------------------|-----------------------|------|-------|------------|
| $I_{GT}$               | $V_D = 12\text{ V}$ , $R_L = 140\text{ }\Omega$                             |                       | Max. | 200   | $\mu$ A    |
| $V_{GT}$               |                                                                             |                       | Max. | 0.8   | V          |
| $V_{RG}$               | $I_{RG} = 10\text{ }\mu$ A                                                  |                       | Min. | 8     | V          |
| $V_{GD}$               | $V_D = V_{DRM}$ , $R_L = 3.3\text{ k}\Omega$ , $R_{GK} = 220\text{ }\Omega$ | $T_j = 125\text{ °C}$ | Min. | 0.1   | V          |
| $I_H$                  | $I_T = 50\text{ mA}$ , $R_{GK} = 1\text{ k}\Omega$                          |                       | Max. | 5     | mA         |
| $I_L$                  | $I_G = 1\text{ mA}$ , $R_{GK} = 1\text{ k}\Omega$                           |                       | Max. | 6     | mA         |
| $dV/dt$                | $V_D = 65\% V_{DRM}$ , $R_{GK} = 220\text{ }\Omega$                         | $T_j = 125\text{ °C}$ | Min. | 5     | V/ $\mu$ s |
| $V_{TM}$               | $I_{TM} = 16\text{ A}$ , $t_p = 380\text{ }\mu$ s                           | $T_j = 25\text{ °C}$  | Max. | 1.6   | V          |
| $V_{th}$               | Threshold voltage                                                           | $T_j = 125\text{ °C}$ | Max. | 0.85  | V          |
| $R_d$                  | Dynamic resistance                                                          | $T_j = 125\text{ °C}$ | Max. | 46    | m $\Omega$ |
| $I_{DRM}$<br>$I_{RRM}$ | $V_{DRM} = V_{RRM}$ , $R_{GK} = 220\text{ }\Omega$                          | $T_j = 25\text{ °C}$  | Max. | 5     | $\mu$ A    |
|                        |                                                                             | $T_j = 125\text{ °C}$ |      | 1     | mA         |

**Table 3. Standard electrical characteristics ( $T_j = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)**

| Symbol                 | Parameter                                               |                                     |      | TN805 | TN815 | TYN608 | Unit             |
|------------------------|---------------------------------------------------------|-------------------------------------|------|-------|-------|--------|------------------|
| $I_{GT}$               | $V_D = 12\text{ V}$ , $R_L = 140\text{ }\Omega$         |                                     | Min. | 0.5   | 2     | 2      | mA               |
|                        |                                                         |                                     | Max. | 5     | 15    | 15     |                  |
| $V_{GT}$               |                                                         |                                     | Max. | 1.3   |       |        | V                |
| $V_{GD}$               | $V_D = V_{DRM}$ , $R_L = 3.3\text{ k}\Omega$            | $T_j = 125\text{ }^{\circ}\text{C}$ | Min. | 0.2   |       |        | V                |
| $I_H$                  | $I_T = 100\text{ mA}$ , gate open                       |                                     | Max. | 25    | 40    | 30     | mA               |
| $I_L$                  | $I_G = 1.2\text{ }I_{GT}$                               |                                     | Max. | 30    | 50    | 70     | mA               |
| $dV/dt$                | $V_D = 67\%\text{ }V_{DRM}$ , gate open                 | $T_j = 125\text{ }^{\circ}\text{C}$ | Min. | 50    | 150   | 150    | V/ $\mu\text{s}$ |
| $V_{TM}$               | $I_{TM} = 16\text{ A}$ , $t_p = 380\text{ }\mu\text{s}$ | $T_j = 25\text{ }^{\circ}\text{C}$  | Max. | 1.6   |       |        | V                |
| $V_{t0}$               | Threshold voltage                                       | $T_j = 125\text{ }^{\circ}\text{C}$ | Max. | 0.85  |       |        | V                |
| $R_d$                  | Dynamic resistance                                      | $T_j = 125\text{ }^{\circ}\text{C}$ | Max. | 46    |       |        | m $\Omega$       |
| $I_{DRM}$<br>$I_{RRM}$ | $V_{DRM} = V_{RRM}$                                     | $T_j = 25\text{ }^{\circ}\text{C}$  | Max. | 5     |       |        | $\mu\text{A}$    |
|                        |                                                         | $T_j = 125\text{ }^{\circ}\text{C}$ |      | 2     |       |        | mA               |

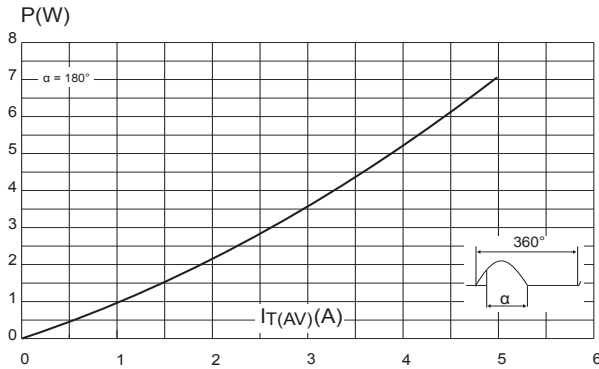
**Table 4. Thermal resistance (maximum values)**

| Symbol        | Parameter             |                             |                        | Value | Unit                 |
|---------------|-----------------------|-----------------------------|------------------------|-------|----------------------|
| $R_{th(j-c)}$ | Junction to case (DC) |                             | IPAK / DPAK / TO-220AB | 1.3   | $^{\circ}\text{C/W}$ |
|               |                       |                             | TO-220FPAB             | 4.6   |                      |
| $R_{th(j-a)}$ | Junction to ambient   | $S^{(1)} = 0.5\text{ cm}^2$ | DPAK                   | 70    | $^{\circ}\text{C/W}$ |
|               | Junction to ambient   |                             | TO-220AB / TO-220FPAB  | 60    |                      |
|               |                       |                             | IPAK                   | 100   |                      |

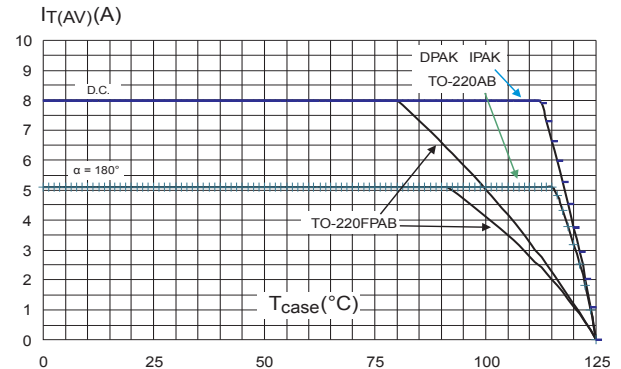
1.  $S$  = Copper surface under tab

## 1.1 Characteristics curves

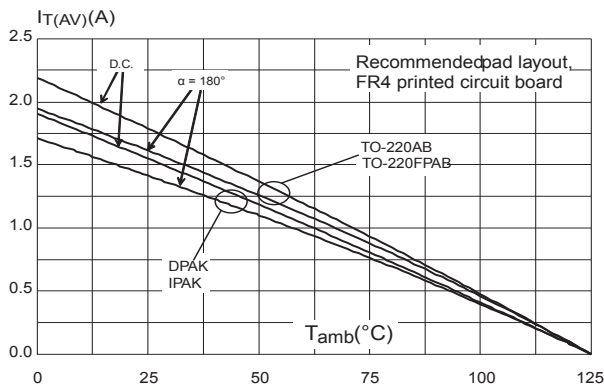
**Figure 1. Maximum average power dissipation versus average on-state current**



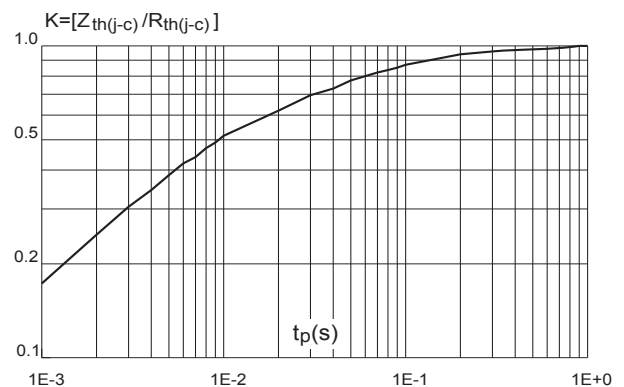
**Figure 2. Average and DC on-state current versus case temperature**



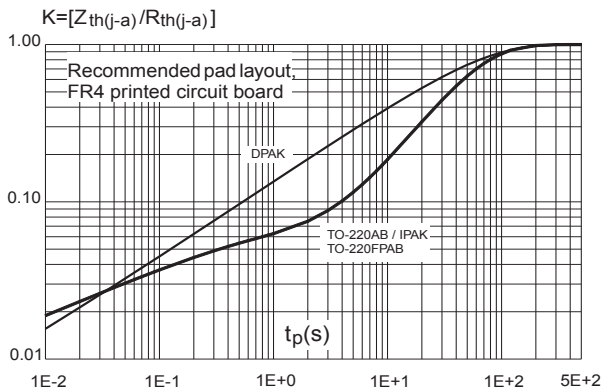
**Figure 3. Average and DC on-state current versus ambient temperature**



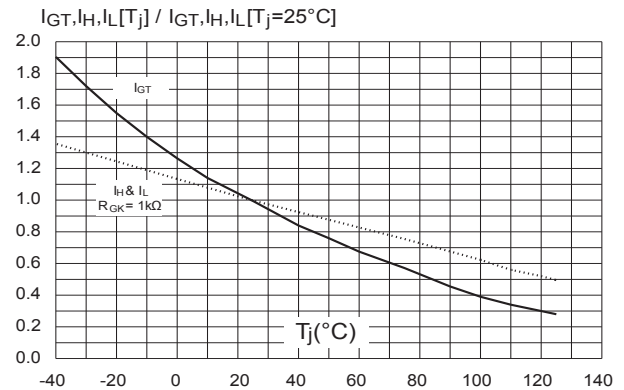
**Figure 4. Relative variation of thermal impedance junction to case versus pulse duration**



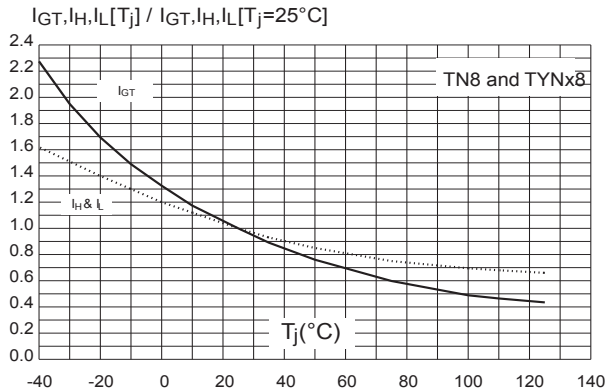
**Figure 5. Relative variation of thermal impedance junction to ambient versus pulse duration**



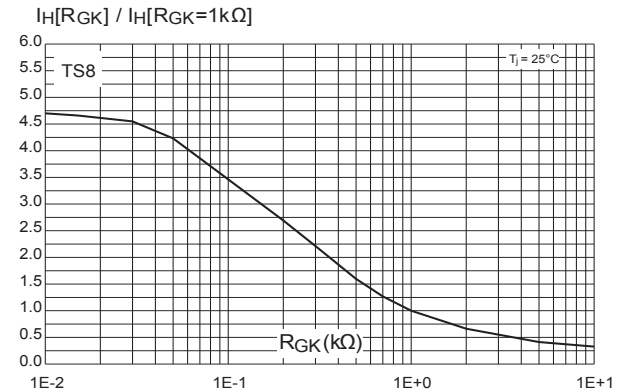
**Figure 6. Relative variation of gate trigger current and holding current versus junction temperature for TS820**



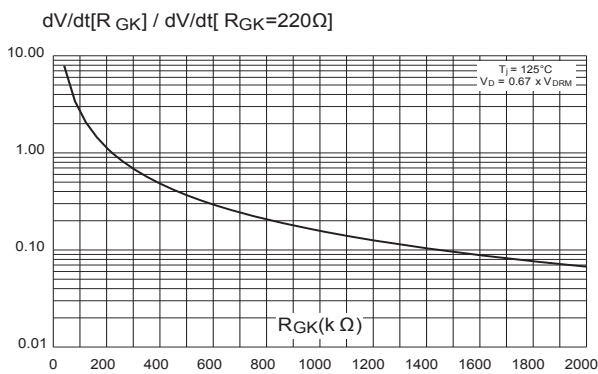
**Figure 7. Relative variation of gate trigger current and holding current versus junction temperature**



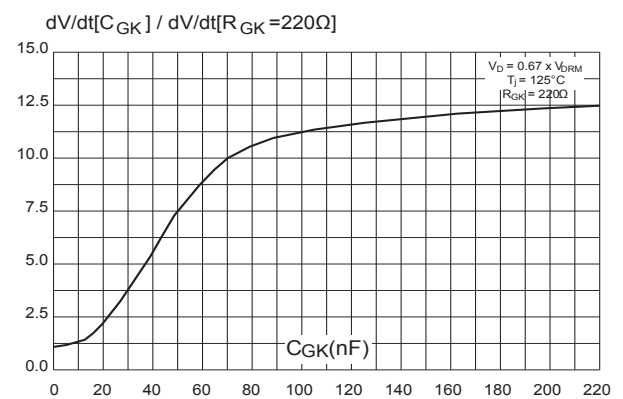
**Figure 8. Relative variation of holding current versus gate-cathode resistance (typical values)**



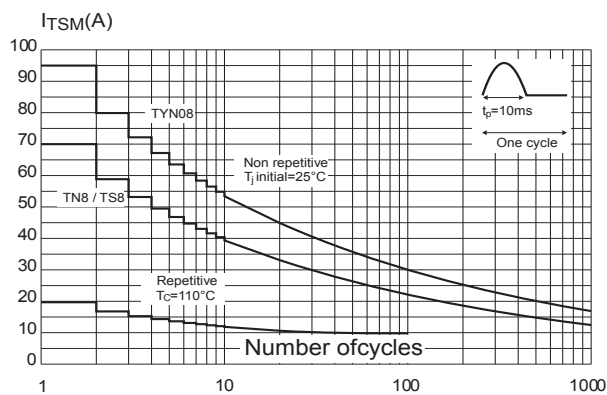
**Figure 9. Relative variation of dV/dt immunity versus gate-cathode resistance (typical values) for TS820**



**Figure 10. Relative variation of dV/dt immunity versus gate-cathode capacitance (typical values) for TS820**



**Figure 11. Surge peak on-state current versus number of cycles**



**Figure 12. Non-repetitive surge peak on-state current and corresponding values of I2t**

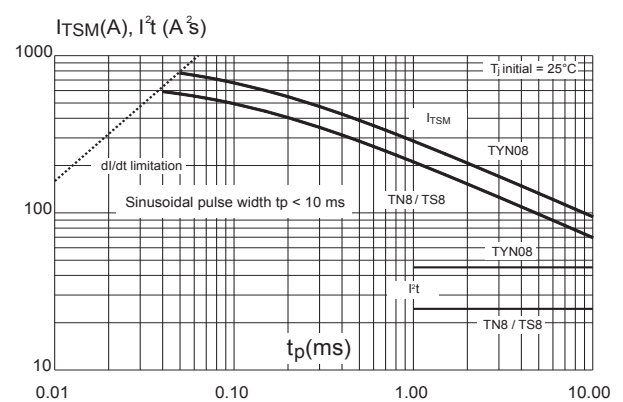


Figure 13. On-state characteristics (maximum values)

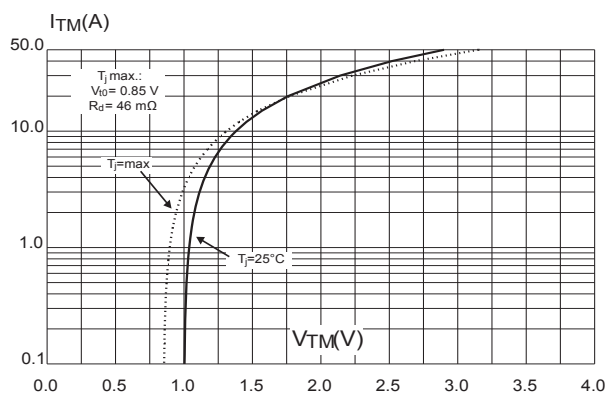
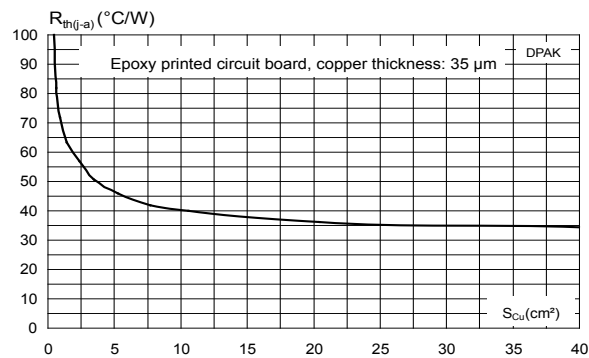


Figure 14. Thermal resistance junction to ambient versus copper surface under tab



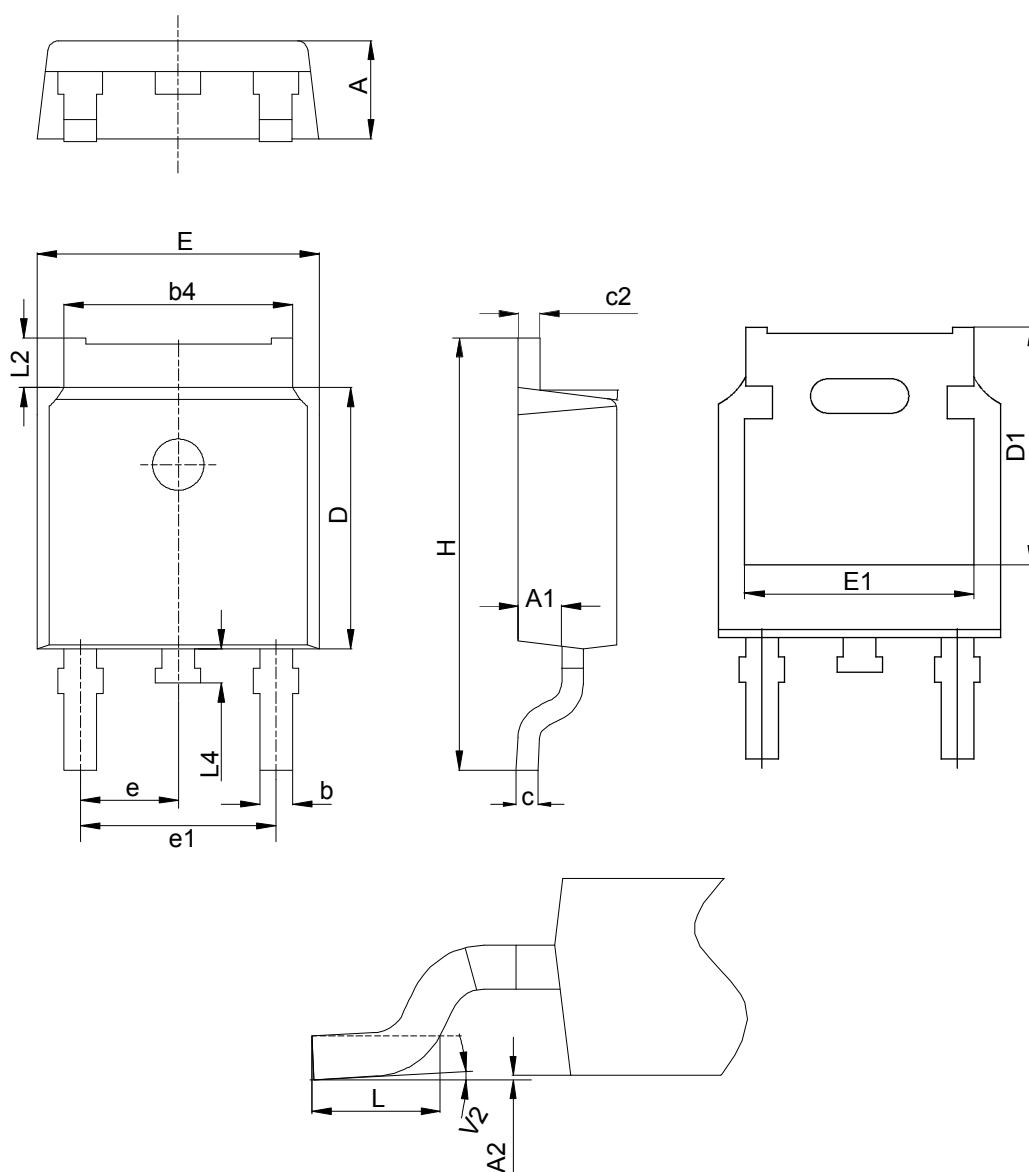
## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 2.1 DPAK package information

- Molding compounded resin is halogen free and meets UL94 flammability standard, level V0
- Lead-free package leads plating

**Figure 15. DPAK package outline**



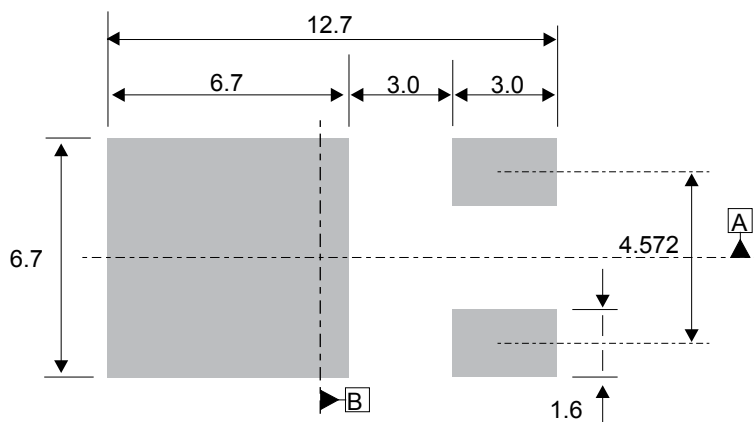
**Table 5. DPAK package mechanical data**

| Ref.              | Dimensions  |       |       |                       |        |        |
|-------------------|-------------|-------|-------|-----------------------|--------|--------|
|                   | Millimeters |       |       | Inches <sup>(1)</sup> |        |        |
|                   | Min.        | Typ.  | Max.  | Min.                  | Typ.   | Max.   |
| A                 | 2.18        |       | 2.40  | 0.0858                |        | 0.0945 |
| A1                | 0.90        |       | 1.10  | 0.0354                |        | 0.0433 |
| A2                | 0.03        |       | 0.23  | 0.0012                |        | 0.0091 |
| b                 | 0.64        |       | 0.90  | 0.0252                |        | 0.354  |
| b4                | 4.95        |       | 5.46  | 0.1949                |        | 0.2150 |
| c                 | 0.46        |       | 0.61  | 0.0181                |        | 0.0240 |
| c2                | 0.46        |       | 0.60  | 0.0181                |        | 0.0236 |
| D                 | 5.97        |       | 6.22  | 0.2350                |        | 0.2449 |
| D1                | 4.95        |       | 5.60  | 0.1949                |        | 0.2205 |
| E                 | 6.35        |       | 6.73  | 0.2500                |        | 0.2650 |
| E1                | 4.32        |       | 5.50  | 0.1701                |        | 0.2165 |
| e                 |             | 2.286 |       |                       | 0.0900 |        |
| e1                | 4.40        |       | 4.70  | 0.1732                |        | 0.1850 |
| H                 | 9.35        |       | 10.40 | 0.3681                |        | 0.4094 |
| L                 | 1.00        |       | 1.78  | 0.0394                |        | 0.0701 |
| L2                |             |       | 1.27  |                       |        | 0.0500 |
| L4                | 0.60        |       | 1.02  | 0.0236                |        | 0.0402 |
| V2 <sup>(2)</sup> | -8°         |       | +8°   | -8°                   |        | +8°    |

1. Dimensions in inches are given for reference only

2. Degree

**Note:** This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

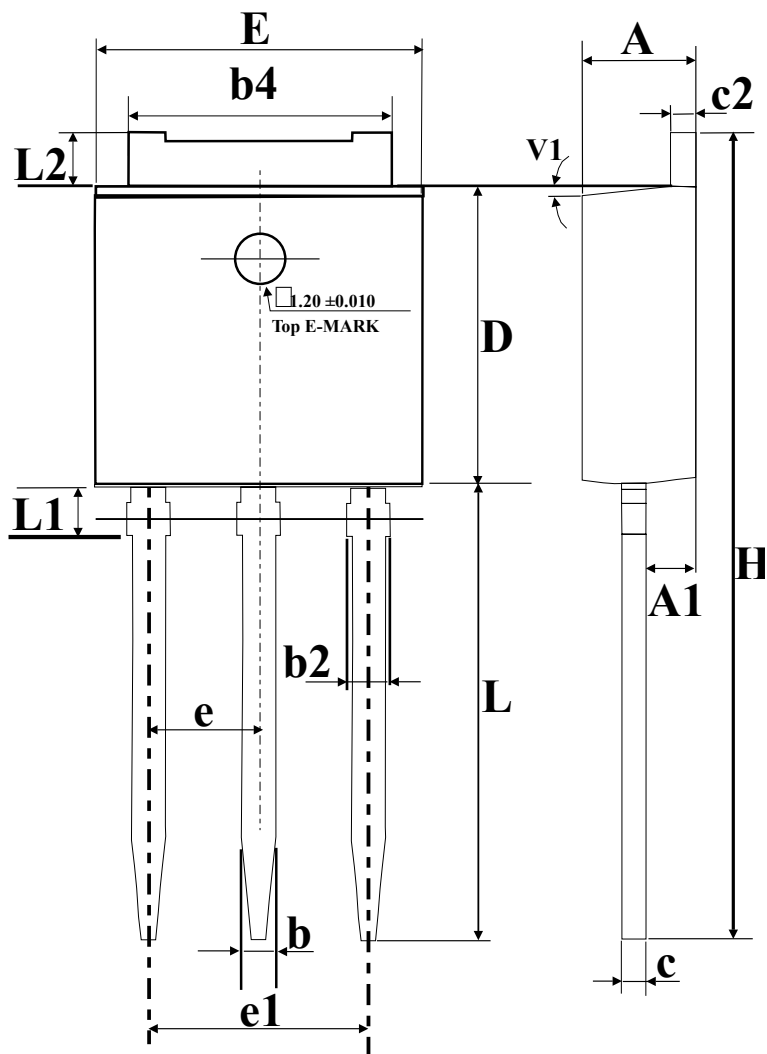
**Figure 16. DPAK recommended footprint (dimensions are in mm)**


The device must be positioned within  $\oplus 0.05$  AB

## 2.2 IPAK package information

- Molding compounded resin is halogen free and meets UL94 flammability standard, level V0
- Lead-free package leads plating

Figure 17. IPAK package outline



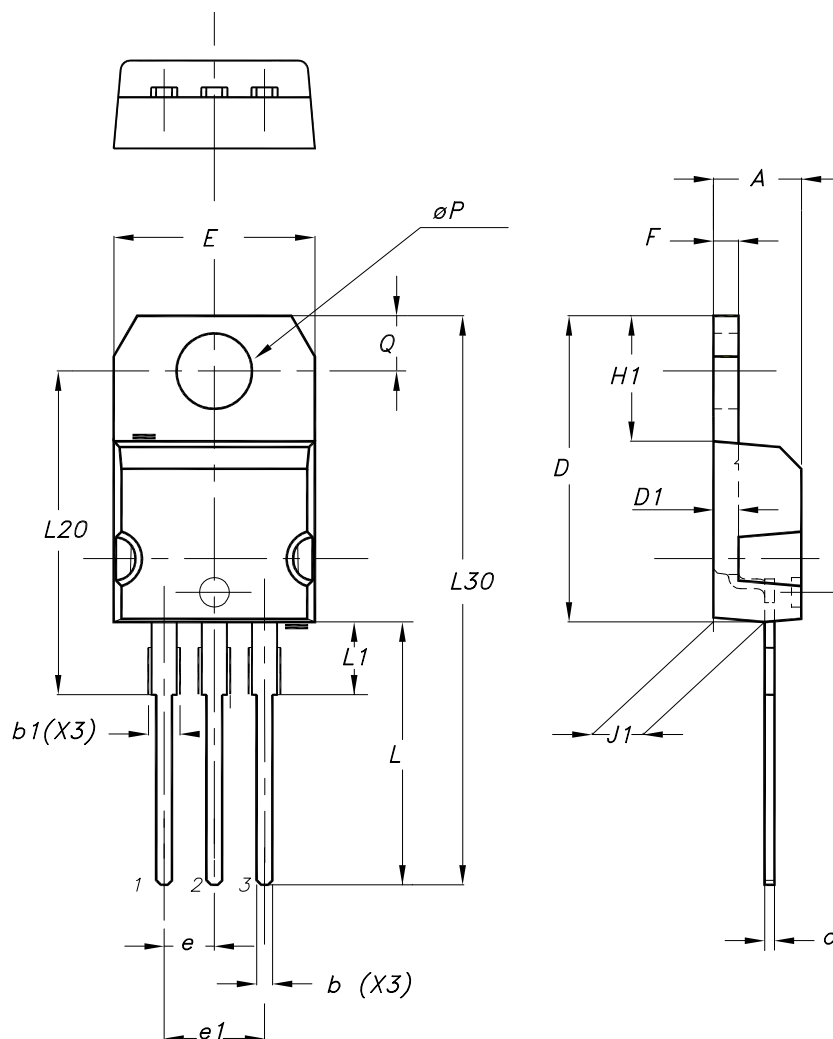
**Table 6. IPAK package mechanical data**

| Ref. | Dimensions                             |       |      |       |       |       |
|------|----------------------------------------|-------|------|-------|-------|-------|
|      | MillimetersInches (for reference only) |       |      |       |       |       |
|      | Min.                                   | Typ.  | Max. | Min.  | Typ.  | Max.  |
| A    | 2.20                                   |       | 2.40 | 0.086 |       | 0.094 |
| A1   | 0.90                                   |       | 1.10 |       |       | 0.035 |
| b    | 0.64                                   |       | 0.90 | 0.025 |       | 0.035 |
| b2   |                                        |       | 0.95 |       |       | 0.037 |
| b4   | 5.20                                   |       | 5.43 |       |       |       |
| c    | 0.45                                   |       | 0.60 |       |       |       |
| c2   | 0.46                                   |       | 0.60 |       |       |       |
| D    | 6                                      |       | 6.20 |       |       |       |
| E    | 6.40                                   |       | 6.70 | 0.252 |       | 0.263 |
| e    |                                        | 2.28  |      |       | 0.090 |       |
| e1   | 4.40                                   |       | 4.60 | 0.173 |       | 0.181 |
| H    |                                        | 16.10 |      |       | 0.634 |       |
| L    | 9                                      |       | 9.60 | 0.354 |       | 0.377 |
| L1   | 0.8                                    |       | 1.20 | 0.031 |       | 0.047 |
| L2   |                                        | 0.80  | 1.25 |       | 0.031 | 0.049 |
| V1   | 10°                                    |       |      |       | 10°   |       |

### 2.3 TO-220AB package information

- Molding compounded resin is halogen free and meets UL94 flammability standard, level V0
- Lead-free package leads plating
- Cooling method: by conduction (C)
- Recommended torque value: 0.55 N·m
- Maximum torque value: 0.70 N·m

**Figure 18. TO-220AB package outline**



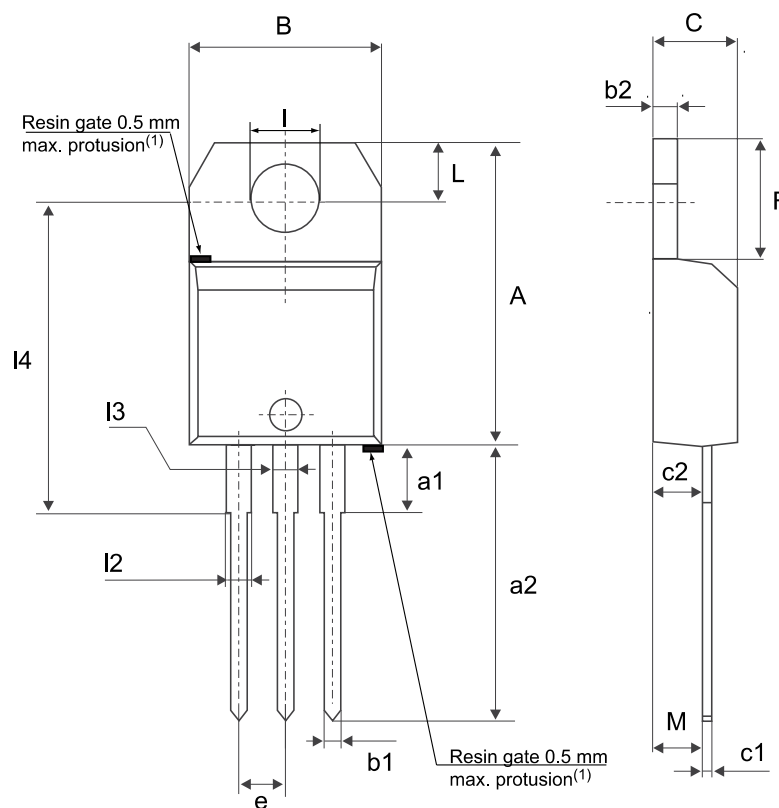
**Table 7. TO-220AB package mechanical data**

| Ref. | Dimensions  |       |                             |       |
|------|-------------|-------|-----------------------------|-------|
|      | Millimeters |       | Inches (for reference only) |       |
|      | Min.        | Max.  | Min.                        | Max.  |
| A    | 4.40        | 4.60  | 0.173                       | 0.181 |
| b    | 0.61        | 0.88  | 0.240                       | 0.035 |
| b1   | 1.14        | 1.55  | 0.045                       | 0.061 |
| c    | 0.48        | 0.70  | 0.019                       | 0.028 |
| D    | 15.25       | 15.75 | 0.600                       | 0.620 |
| D1   | 1.27 typ.   |       | 0.050 typ.                  |       |
| E    | 10.00       | 10.40 | 0.394                       | 0.409 |
| e    | 2.40        | 2.70  | 0.094                       | 0.106 |
| e1   | 4.95        | 5.15  | 0.195                       | 0.203 |
| F    | 1.23        | 1.32  | 0.048                       | 0.052 |
| H1   | 6.20        | 6.60  | 0.244                       | 0.260 |
| J1   | 2.40        | 2.72  | 0.094                       | 0.107 |
| L    | 13.00       | 14.00 | 0.512                       | 0.551 |
| L1   | 3.50        | 3.93  | 0.138                       | 0.155 |
| L20  | 16.40 typ.  |       | 0.646 typ.                  |       |
| L30  | 28.90 typ.  |       | 1.138 typ.                  |       |
| θP   | 3.75        | 3.85  | 0.148                       | 0.152 |
| Q    | 2.65        | 2.95  | 0.104                       | 0.116 |

## 2.4 TO-220AB package information

- Molding compound resin is halogen free and meets UL94 flammability standard, level V0
- Lead-free plating package leads
- Recommended torque: 0.4 to 0.6 N·m

Figure 19. TO-220AB package outline



(1) Resin gate position accepted in one of the two positions or in the symmetrical opposites.

**Table 8. TO-220AB package mechanical data**

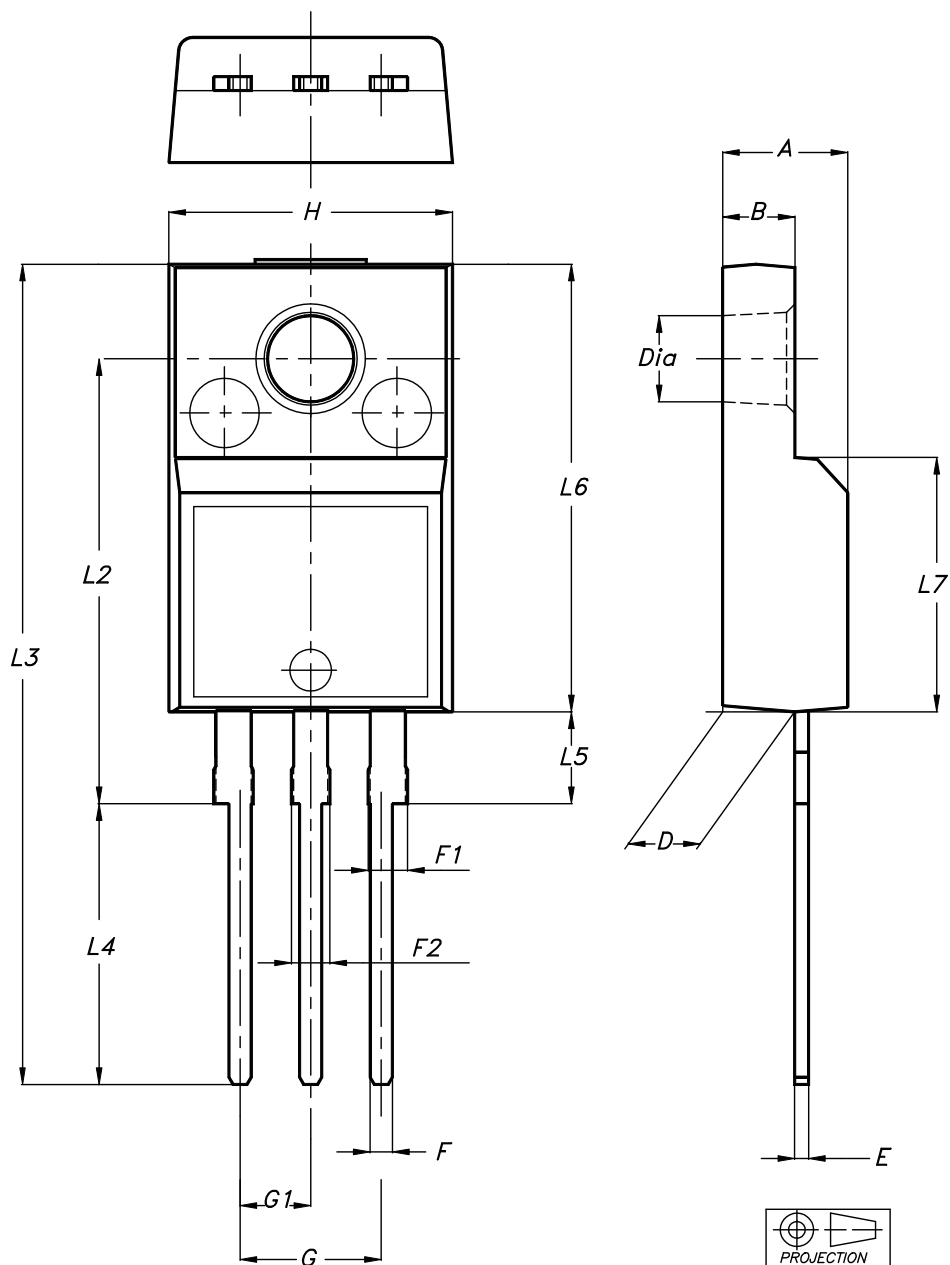
| Ref. | Dimensions  |       |       |                       |        |        |
|------|-------------|-------|-------|-----------------------|--------|--------|
|      | Millimeters |       |       | Inches <sup>(1)</sup> |        |        |
|      | Min.        | Typ.  | Max.  | Min.                  | Typ.   | Max.   |
| A    | 15.20       |       | 15.90 | 0.5984                |        | 0.6260 |
| a1   |             | 3.75  |       |                       | 0.1476 |        |
| a2   | 13.00       |       | 14.00 | 0.5118                |        | 0.5512 |
| B    | 10.00       |       | 10.40 | 0.3937                |        | 0.4094 |
| b1   | 0.61        |       | 0.88  | 0.0240                |        | 0.0346 |
| b2   | 1.23        |       | 1.32  | 0.0484                |        | 0.0520 |
| C    | 4.40        |       | 4.60  | 0.1732                |        | 0.1811 |
| c1   | 0.49        |       | 0.70  | 0.0193                |        | 0.0276 |
| c2   | 2.40        |       | 2.72  | 0.0945                |        | 0.1071 |
| e    | 2.40        |       | 2.70  | 0.0945                |        | 0.1063 |
| F    | 6.20        |       | 6.60  | 0.2441                |        | 0.2598 |
| I    | 3.73        |       | 3.88  | 0.1469                |        | 0.1528 |
| L    | 2.65        |       | 2.95  | 0.1043                |        | 0.1161 |
| l2   | 1.14        |       | 1.70  | 0.0449                |        | 0.0669 |
| l3   | 1.14        |       | 1.70  | 0.0449                |        | 0.0669 |
| l4   | 15.80       | 16.40 | 16.80 | 0.6220                | 0.6457 | 0.6614 |
| M    |             | 2.6   |       |                       | 0.1024 |        |

1. Inch dimensions are for reference only.

## 2.5 TO-220FPAB package information

- Epoxy meets UL94, V0
- Recommended torque: 0.4 to 0.6 N·m

Figure 20. TO-220FPAB package outline



**Table 9. TO-220FPAB package mechanical data**

| Ref. | Dimensions  |       |             |        |
|------|-------------|-------|-------------|--------|
|      | Millimeters |       | Inches      |        |
|      | Min.        | Max.  | Min.        | Max.   |
| A    | 4.40        | 4.60  | 0.1739      | 0.1818 |
| B    | 2.5         | 2.7   | 0.0988      | 0.1067 |
| D    | 2.50        | 2.75  | 0.0988      | 0.1087 |
| E    | 0.45        | 0.70  | 0.0178      | 0.0277 |
| F    | 0.75        | 1.0   | 0.0296      | 0.0395 |
| F1   | 1.15        | 1.70  | 0.0455      | 0.0672 |
| F2   | 1.15        | 1.70  | 0.0455      | 0.0672 |
| G    | 4.95        | 5.20  | 0.1957      | 0.2055 |
| G1   | 2.40        | 2.70  | 0.0949      | 0.1067 |
| H    | 10.00       | 10.40 | 0.3953      | 0.4111 |
| L2   | 16.00 typ.  |       | 0.6324 typ. |        |
| L3   | 28.60       | 30.60 | 1.1304      | 1.2095 |
| L4   | 9.80        | 10.6  | 0.3874      | 0.4190 |
| L5   | 2.90        | 3.60  | 0.1146      | 0.1423 |
| L6   | 15.90       | 16.40 | 0.6285      | 0.6482 |
| L7   | 9.00        | 9.30  | 0.3557      | 0.3676 |
| Dia  | 3.0         | 3.20  | 0.1186      | 0.1265 |

### 3 Ordering information

Figure 21. TN8 series

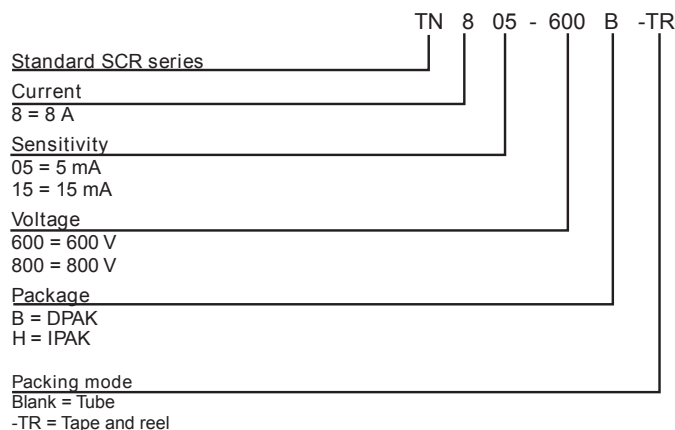


Figure 22. TS8 series

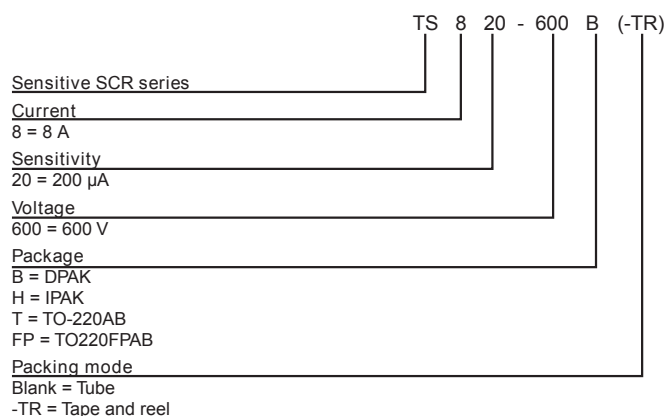
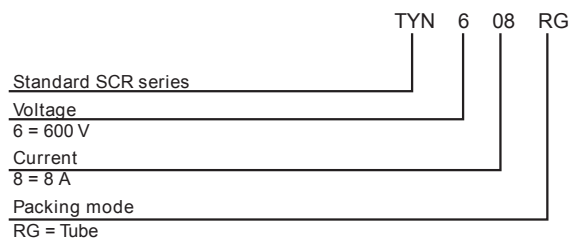


Figure 23. TYNx08 series



**Table 10. Ordering information**

| Order code    | Marking   | Package    | Weight | Base qty | Delivery mode |
|---------------|-----------|------------|--------|----------|---------------|
| TN805-600B-TR | TN805600  | DPAK       | 0.3 g  | 2500     | Tape and reel |
| TN815-600B-TR | TN815600  | DPAK       | 0.3 g  | 2500     | Tape and reel |
| TN815-800B-TR | TN815800  | DPAK       | 0.3 g  | 2500     | Tape and reel |
| TN815-800H    | TN815800  | IPAK       | 0.4 g  | 75       | Tube          |
| TS820-600B    | TS820600  | DPAK       | 0.3 g  | 75       | Tube          |
| TS820-600B-TR | TS820600  | DPAK       | 0.3 g  | 2500     | Tape and reel |
| TS820-600H    | TS820600  | IPAK       | 0.4 g  | 75       | Tube          |
| TS820-600T    | TS820600T | TO-220AB   | 2.3 g  | 50       | Tube          |
| TS820-600FP   | TS820600  | TO-220FPAB | 2.0 g  | 50       | Tube          |
| TYN608RG      | TYN608    | TO-220AB   | 2.3 g  | 50       | Tube          |

## Revision history

**Table 11. Document revision history**

| Date        | Revision | Changes                                                                                         |
|-------------|----------|-------------------------------------------------------------------------------------------------|
| Apr-2002    | 4A       | Last update.                                                                                    |
| 13-Feb-2006 | 5        | TO-220AB delivery mode changed from bulk to tube. ECOPACK statement added.                      |
| 22-Jan-2010 | 6        | Alpha definition updated in Figure 1. Thermal resistance, junction to case, updated in Table 5. |
| 10-Oct-2011 | 7        | Added TO-220FPAB package. Removed 700 V and 1000 V products.                                    |
| 14-May-2014 | 8        | Updated DPAK and IPAK package information and reformatted to current standard.                  |
| 03-Nov-2021 | 9        | Added TN815-800H product information. Minor text changes.                                       |

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